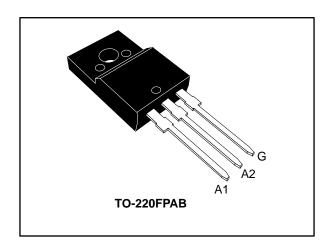
# T405T-6FP



## 4 A logic level Triac

Datasheet - production data



#### **Features**

- Three triggering quadrants Triac
- $V_{DRM} / V_{RRM} = 600 V$
- UL certified device rated 2000 V<sub>RMS</sub> (ref. file E81734)
- ECOPACK®2 compliant component
- Halogen-free molding, lead-free plating

### **Applications**

- General purpose AC inductive loads
- Induction motor control circuits
- Small home appliances

#### **Benefits**

- Low gate consumption
- Direct drive from microcontroller
- Direct mounting on heat sink

### **Description**

Based on ST's logic level technology providing high commutation performance, this device is suitable for use on AC low current loads. It is recommended for motor driving, electro valves, kitchen appliances, power tools and dishwashers. Available in a fully insulated package, it complies with standard UL1557.

**Table 1: Device summary** 

Symbol	Value	Unit
I <sub>T(RMS)</sub>	4	Α
V <sub>DRM</sub> /V <sub>RRM</sub>	600	V
lgт	5	mA
T <sub>j</sub> max.	125	°C
Package	TO-220FPAB T405T-6FP	
Ordering code		

Characteristics T405T-6FP

### 1 Characteristics

Table 2: Absolute maximum ratings (limiting values)

Symbol	Parameter			Value	Unit
I <sub>T(RMS)</sub>	RMS on-state current (full sine wave)		T <sub>c</sub> = 104 °C	4	Α
	Non repetitive surge	$t_p = 16.7 \text{ ms}$		31	
Ітѕм	peak on-state current (full sine cycle)	t <sub>p</sub> = 20 ms	T <sub>j</sub> initial = 25 °C	30	А
l <sup>2</sup> t	I <sup>2</sup> t value for fusing	$t_p = 10 \text{ ms}$	$T_j$ initial = 25 °C	5.1	A <sup>2</sup> s
dl/dt	Critical rate of rise of on- state current	$I_G = 2 \times I_{GT}$ , $t_r \le 100 \text{ ns}$	f = 120 Hz	50	A/µs
I <sub>GM</sub>	Peak gate current			4	Α
P <sub>GM</sub>	Maximum gate power dissipation	t <sub>p</sub> = 20 μs	T <sub>j</sub> = 125 °C	1	W
T <sub>stg</sub>	Storage junction temperature range			-40 to +150	°C
Tj	Operating junction temperature range			-40 to +125	°C
TL	Maximum lead temperature for soldering during 10 s			260	°C
Vins	Insulation RMS voltage (60 seconds)			2000	V

**Table 3: Static electrical characteristics** 

Symbol	Test conditions T <sub>j</sub>			Value	Unit
$V_{TM}$	$I_{TM} = 5.5 \text{ A}, t_p = 380  \mu\text{s}$	25 °C	Max.	1.56	V
$V_{TO}$	threshold on-state voltage	125 °C	Max.	0.9	V
$R_D$	Dynamic resistance	125 °C	Max.	100	mΩ
I <sub>DRM</sub>	No Moon No Moon	25 °C	Max.	5	μΑ
I <sub>RRM</sub>	$V_D = V_{DRM}, V_R = V_{RRM}$	125 °C	Max.	1	mA

**Table 4: Dynamic characteristics** 

Symbol	Parameter Qua		Tj		Value	Unit
I <sub>GT</sub> <sup>(1)</sup>	V 42 V D = 20 O		25 °C	Max.	5	mA
V <sub>GT</sub>	$V_D = 12 \text{ V}, R_L = 30 \Omega$	1 - 11 - 111		Max.	1.3	V
$V_{GD}$	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$		125 °C	Min.	0.2	V
IL	I <sub>G</sub> = 1.2 x I <sub>GT</sub>		25 °C	Max.	15	<b>∞</b> ^
Ін	I <sub>TM</sub> = 100 mA		25 °C	Max.	10	mA
dV/dt <sup>(2)</sup>	$V_D = V_R = 402 \text{ V}$ , gate open		125 °C	Min.	20	V/µs
(dl/dt)c <sup>(2)</sup>	(dV/dt)c = 0.1 V/μs		125 °C	Min.	1.8	A/ms

#### Notes:

 $<sup>^{(1)}\!</sup>M$ inimum IgT is guaranteed at 5 % of IgT max.

<sup>&</sup>lt;sup>(2)</sup>For both polarities of A2 referenced to A1

T405T-6FP Characteristics

#### **Table 5: Thermal resistance**

Symbol	Parameter		Unit
R <sub>th(j-c)</sub>	Max. junction to case thermal resistance (AC)	4.3	°C/W
R <sub>th(j-a)</sub>	Typical junction to ambient thermal resistance	60	°C/VV

Characteristics T405T-6FP

# 1.1 Characteristics (curves)

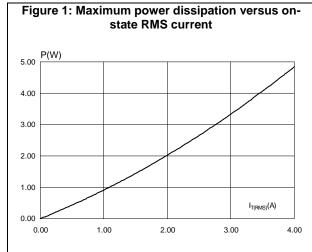


Figure 2: RMS on-state current versus temperature under tab. (full cycle)

1T(RMS)(A)

4.00

2.00

1.00

0 25 50 75 100 125

Figure 3: RMS on-state current versus ambient temperature (free air convection)

2.50

1.50

1.00

0.50

0.00

25

50

75

100

125

Figure 4: Relative variation of thermal impedance versus pulse duration

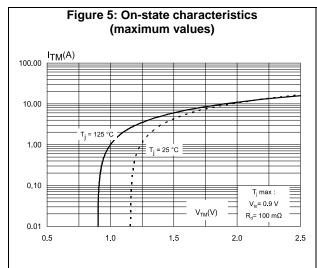
1.0E+00

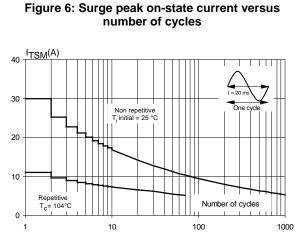
K = [Z<sub>th</sub>/R<sub>th</sub>]

1.0E-01

1.0E-02

1.0E-03 1.0E-02 1.0E-01 1.0E+00 1.0E+01 1.0E+02 1.0E+03 1.0E+04





T405T-6FP Characteristics

Figure 7: Non repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10 \text{ ms}$ 1.E+04

1.E+03

1.E+01

1.E+01

1.E+01

1.E+00

1.O0

1.O0

1.O0

Figure 8: Relative variation of gate trigger current and gate trigger voltage versus junction temperature (typical values)

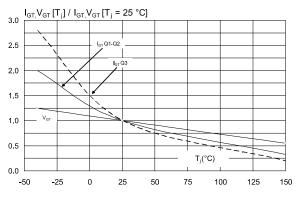


Figure 9: Relative variation of holding current and latching current versus junction temperature (typical values)

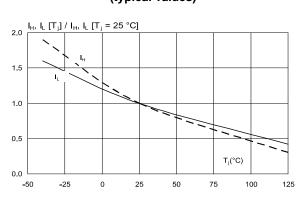


Figure 10: Relative variation of critical rate of decrease of main current (dl/dt)c versus reapplied (dV/dt)c

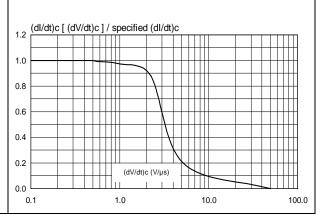


Figure 11: Relative variation of critical rate of decrease of main current versus junction temperature (typical values)

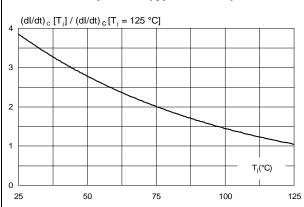
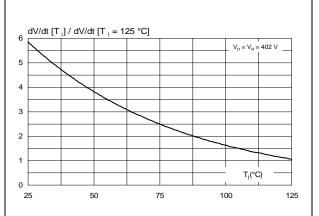


Figure 12: Relative variation of static dV/dt immunity versus junction temperature



Package information T405T-6FP

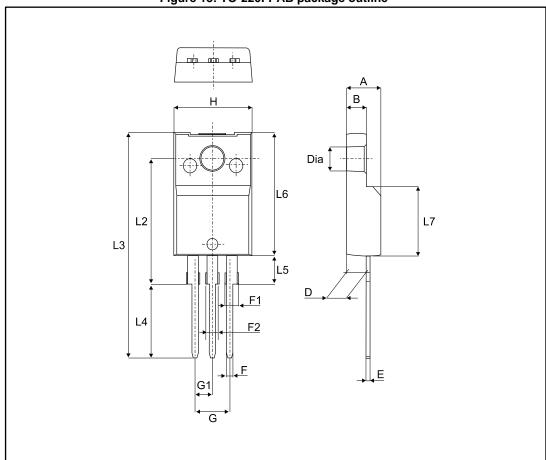
## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

- ECOPACK®2 compliant
- Lead-free package leads finishing
- Molding compound resin is halogen-free and meets UL94 level V0
- Recommended torque (for through-hole package): 0.4 to 0.6 N·m

## 2.1 TO-220FPAB package information

Figure 13: TO-220FPAB package outline



T405T-6FP Package information

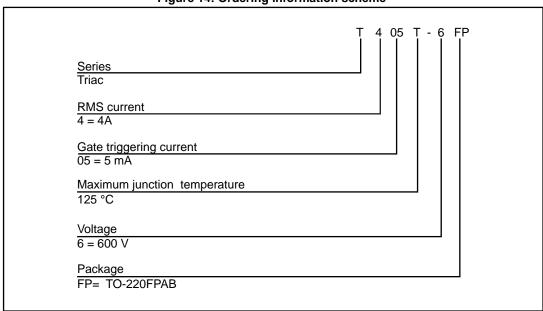
Table 6: TO-220FPAB package mechanical data

	Dimensions				
Ref.	Millin	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
Α	4.40	4.60	0.1739	0.1818	
В	2.5	2.7	0.0988	0.1067	
D	2.50	2.75	0.0988	0.1087	
Е	0.45	0.70	0.0178	0.0277	
F	0.75	1.0	0.0296	0.0395	
F1	1.15	1.70	0.0455	0.0672	
F2	1.15	1.70	0.0455	0.0672	
G	4.95	5.20	0.1957	0.2055	
G1	2.40	2.70	0.0949	0.1067	
Н	10.00	10.40	0.3953	0.4111	
L2	16.0	0 typ.	0.632	4 typ.	
L3	28.60	30.60	1.1304	1.2095	
L4	9.80	10.6	0.3874	0.4190	
L5	2.90	3.60	0.1146	0.1423	
L6	15.90	16.40	0.6285	0.6482	
L7	9.00	9.30	0.3557	0.3676	
Dia	3.0	3.20	0.1186	0.1265	

Ordering information T405T-6FP

# 3 Ordering information

Figure 14: Ordering information scheme



**Table 7: Ordering information** 

Order code	Marking	Package	Weight	Base qty.	Delivery mode
T405T-6FP	T405T-6FP	TO-220FPAB	2.0 g	50	Tube

# 4 Revision history

**Table 8: Document revision history** 

Date	Revision	Changes
04-Nov-2016	1	Inital release.

#### **IMPORTANT NOTICE - PLEASE READ CAREFULLY**

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2016 STMicroelectronics - All rights reserved

